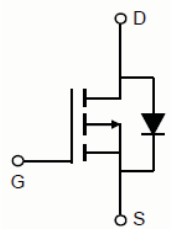
RECTRON SEMICONDUCTOR
TECHNICAL SPECIFICATION

RM45P20D3

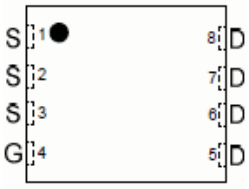
P-Channel Enhancement Mode Power MOSFET

Description

The RM45P20D3 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.



Schematic diagram



Pin Assignment

DFN 3.3x3.3 EP top view

General Features

- V_{DS} =-19V,I_D =-45A
  $R_{DS(ON)}$ < 7mΩ @ V_{GS}=-4.5V
  $R_{DS(ON)}$ < 9mΩ @ V_{GS}=-2.5V
  $R_{DS(ON)}$ < 12mΩ @ V_{GS}=-1.8V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Load switch
- Battery protection

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
45P20	RM45P20D3	DFN 3.3x3.3 EP	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	-19	V
Gate-Source Voltage	V_{GS}	±12	V
Drain Current-Continuous	I_D	-45	A
Drain Current-Continuous(T_C=100℃)	I_D (100℃)	-35	A
Pulsed Drain Current	I_{DM}	-200	A
Maximum Power Dissipation	P_D	80	W
Derating factor		0.64	W/℃
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 150	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Case(Note 2)	$R_{\theta JC}$	1.6	℃/W

Electrical Characteristics (T_C=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=-250μA	-19	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-16V,V_{GS}=0V	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±12V,V_{DS}=0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=-250μA	-0.4	-0.6	-1.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=-4.5V, I_D=-20A	-	5.8	7	mΩ
		V_{GS}=-2.5V, I_D=-20A	-	7.2	9	
		V_{GS}=-1.8V, I_D=-20A		9	12	
Forward Transconductance	g_{FS}	V_{DS}=-5V,I_D=-20A	80	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C_{lss}	V_{DS}=-10V,V_{GS}=0V, F=1.0MHz	-	3500	-	PF
Output Capacitance	C_{oss}		-	577	-	PF
Reverse Transfer Capacitance	C_{rss}		-	445	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=-10V, R_{GEN}=3Ω V_{GS}=-4.5V,R_L=0.5Ω	-	18	-	nS
Turn-on Rise Time	t_r		-	42	-	nS
Turn-Off Delay Time	$t_{d(off)}$		-	85	-	nS
Turn-Off Fall Time	t_f		-	23	-	nS
Total Gate Charge	Q_g	V_{DS}=-10V,I_D=-20A, V_{GS}=-4.5V	-	55	-	nC
Gate-Source Charge	Q_{gs}		-	10	-	nC
Gate-Drain Charge	Q_{gd}		-	15	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS}=0V,I_S=-20A	-	-	-1.2	V
Diode Forward Current (Note 2)	I_S		-	-	-45	A
Reverse Recovery Time	t_{rr}	TJ = 25°C, IF = -10A di/dt = 100A/μs (Note3)	-	47	-	nS
Reverse Recovery Charge	Qrr		-	53	-	nC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

RATING AND CHARACTERISTICS CURVES (RM45P20D3)

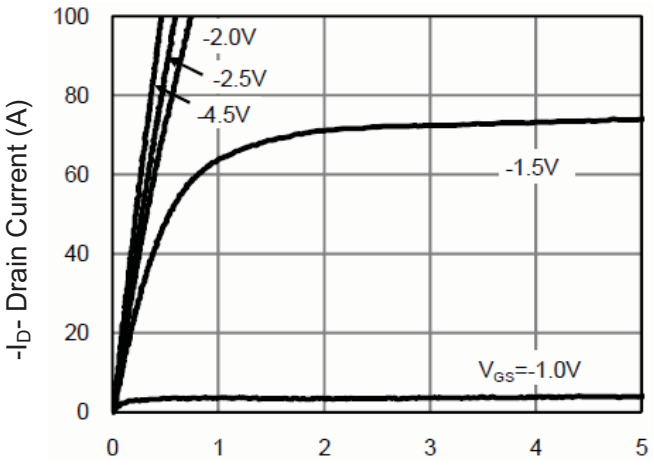


Figure 1 Output Characteristics

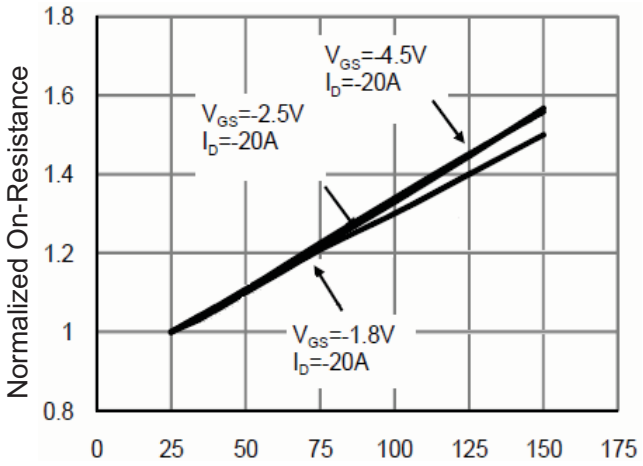


Figure 4 Rdson-Junction Temperature

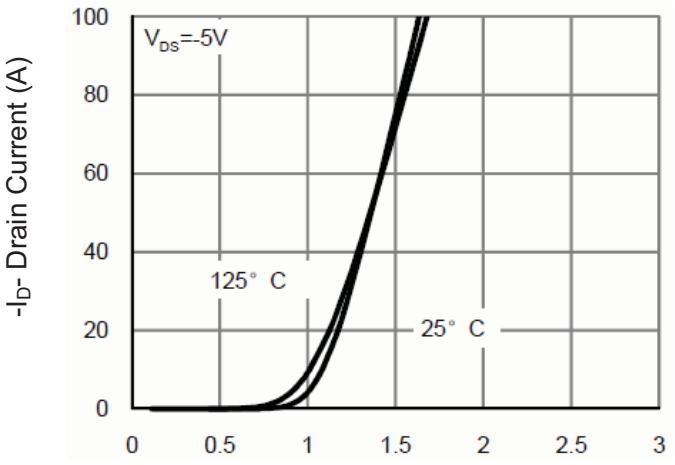


Figure 2 Transfer Characteristics

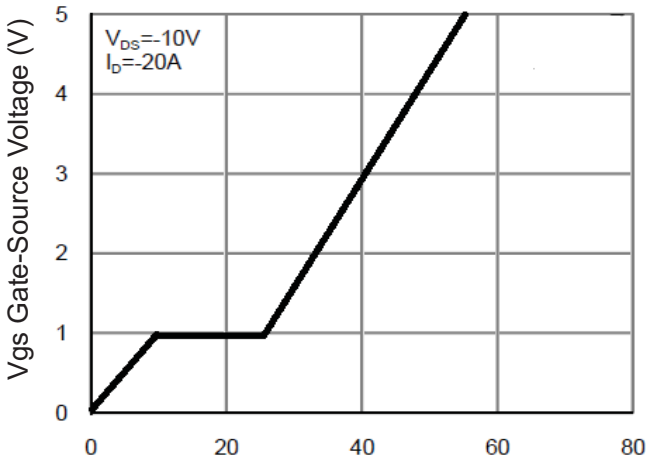


Figure 5 Gate Charge

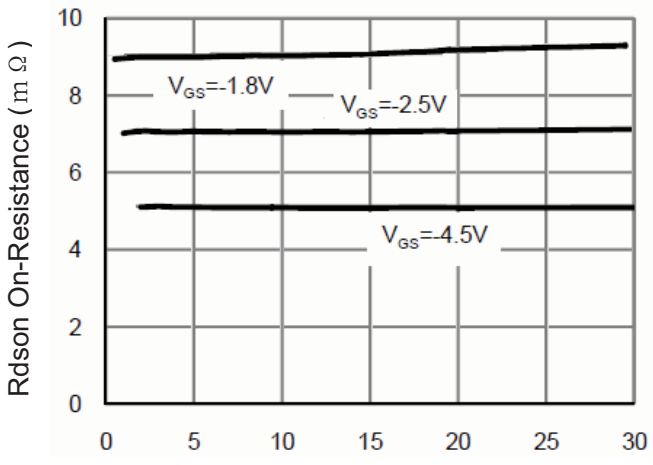


Figure 3 Rdson- Drain Current

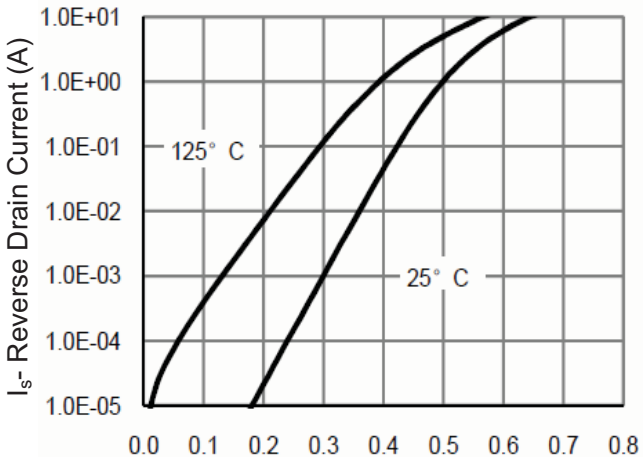


Figure 6 Source- Drain Diode Forward

RATING AND CHARACTERISTICS CURVES (RM45P20D3)

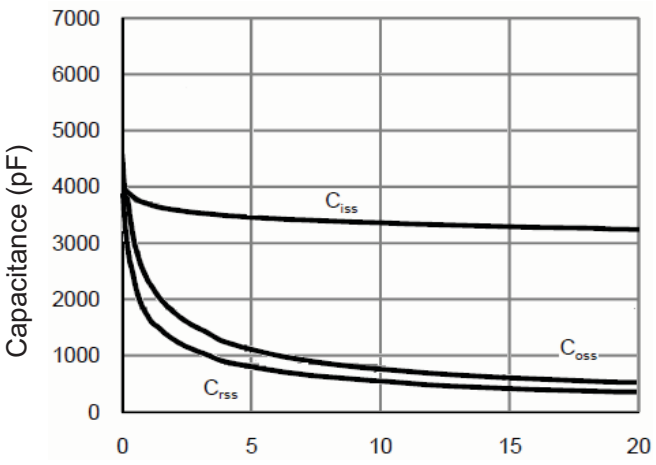


Figure 7 Capacitance vs Vds

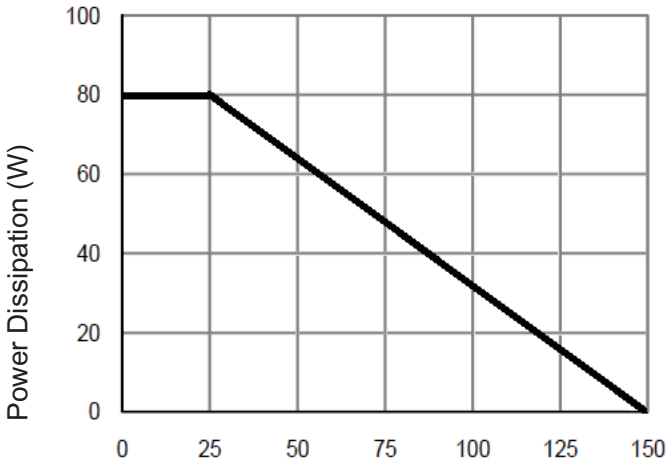


Figure 9 Power De-rating

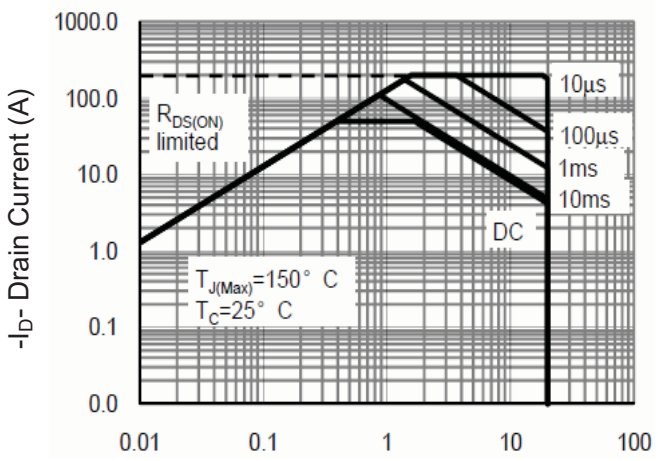


Figure 8 Safe Operation Area

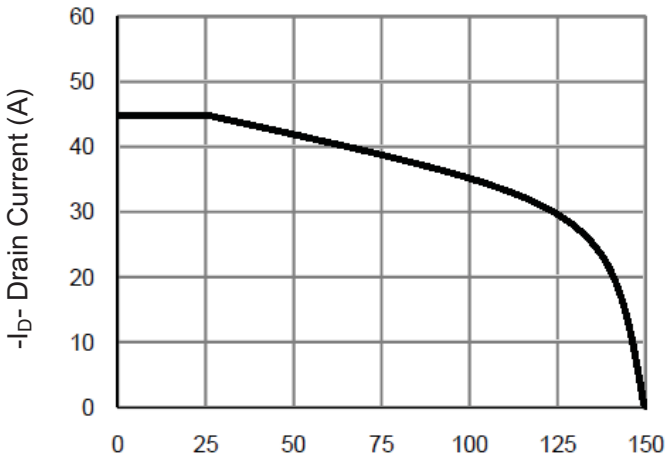


Figure 10 -Current De-rating

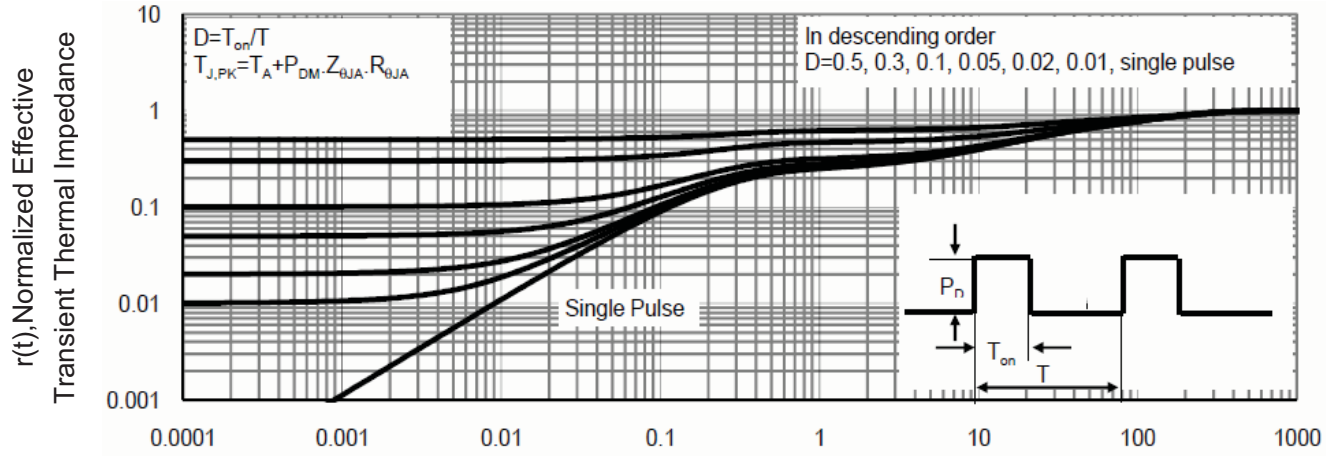
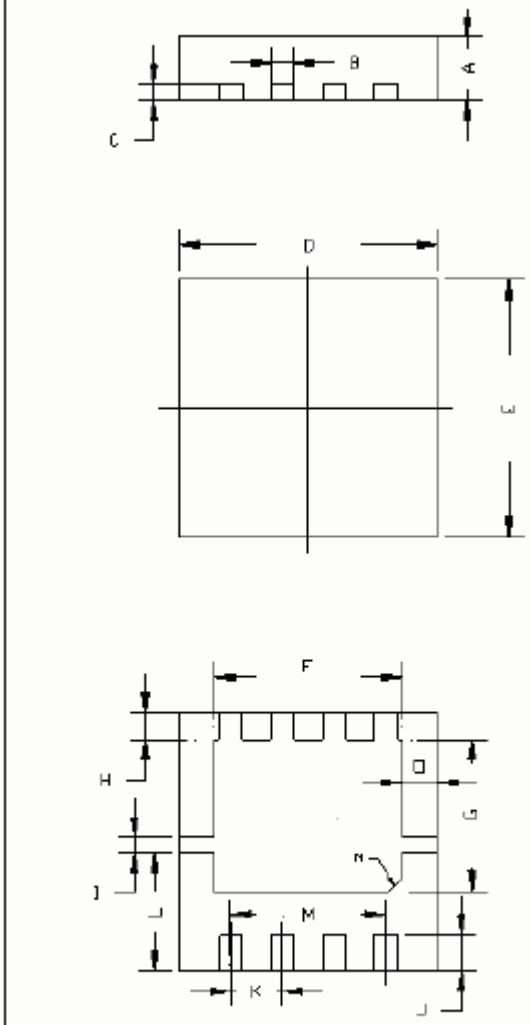


Figure 11 Normalized Maximum Transient Thermal Impedance

DFN3.3X3.3 EP Package Information

封装外形尺寸图



符号	单位：mm		
	MIN	MAX	TYP
A	0.75	0.85	0.8
B	0.25	0.35	0.3
C	0.18	0.22	0.2
D	3.2	3.3	3.25
E	3.2	3.3	3.25
F	2.2	2.5	2.35
G	1.8	2.0	1.9
H	0.3	0.4	0.35
I	0.15	0.25	0.2
J	0.4	0.5	0.45
K	0.6	0.7	0.65
L	1.38	1.58	1.48
M	1.8	2.1	1.95
N	0.15*45°		
O	0.4	0.5	0.45

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